

DATA SHEET

# SKY65723-81: Low-Noise Amplifier Front-End Module with GPS/GNSS/BDS Pre-Filter

## Applications

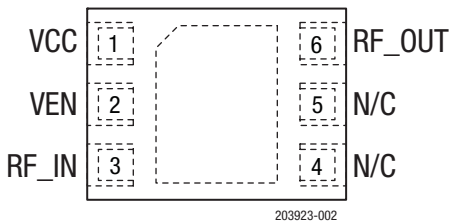
- GPS/GNSS/BDS radio receivers
- Global Navigation Satellite Systems (GLONASS)
- Fitness/activity trackers
- Smartphones
- Laptop PCs and tablets

## Features

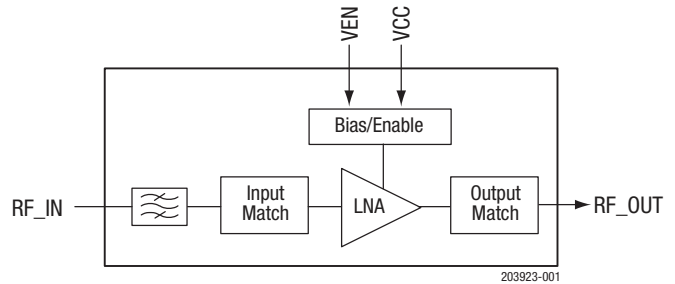
- Small signal gain: 16.5 dB typical
- Low noise figure: 1.5 dB typical
- Excellent out-of-band rejection
- Low current consumption
- Input/output impedance internally matched to 50 Ω
- Single DC supply: 1.62 to 3.6 V
- Minimal number of external components required
- Small MCM (6-pin, 1.7 x 2.3 mm) package (MSL3, 260 °C per JEDEC J-STD-020)



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**Figure 2. SKY65723-81 Pinout (Top View)**



**Figure 1. SKY65723-81 Block Diagram**

## Description

The SKY65723-81 is a front-end module (FEM) with an integrated low-noise amplifier (LNA) and pre-filter designed for Global Positioning System/Global Navigation Satellite System/Beidou Navigation Satellite System (GPS/GNSS/BDS) receiver applications. The device provides high linearity, excellent gain, a high 1 dB input compression point (IP1dB), and a superior noise figure (NF).

The pre-filter provides the low in-band insertion loss and integrated notch filtering for excellent rejections of the cellular, PCS, and WLAN frequency bands. The SKY65723-81 uses surface-mount technology (SMT) in the form of a 1.7 x 2.3 mm Multi-Chip Module (MCM) package, which allows for a highly manufacturable and low-cost solution.

A functional block diagram is shown in Figure 1. The pin configuration and package are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.

**Table 1. SKY65723-81 Signal Descriptions**

| Pin | Name  | Description    | Pin | Name   | Description   |
|-----|-------|----------------|-----|--------|---|
| 1   | VCC   | Source voltage | 4   | N/C    | Not connected or grounded with no impact to performance |
| 2   | VEN   | LNA enable     | 5   | N/C    | Not connected or grounded with no impact to performance |
| 3   | RF_IN | RF input       | 6   | RF_OUT | RF output   |

## Technical Description

### LNA Enable

The VEN signal (pin 2) enables or disables the LNA. A logic high signal powers on the LNA and a logic low signal powers off the device.

## Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY65723-81 are provided in Table 2. The recommended operating conditions are specified in Table 3, and electrical specifications are provided in Tables 4 and 5.

**Table 2. SKY65723-81 Absolute Maximum Ratings<sup>1</sup>**

| Parameter  | Symbol           | Minimum | Maximum | Units |
|--|------------------|---------|---------|-------|
| RF input power   | P <sub>IN</sub>  |         | +10     | dBm   |
| Supply voltage   | V <sub>CC</sub>  | 0       | 4.5     | V     |
| Storage temperature  | T <sub>STG</sub> | -55     | +150    | °C    |
| Junction temperature   | T <sub>J</sub>   |         | +150    | °C    |
| Electrostatic discharge:<br>Human Body Model (HBM), Class 1A<br>(at RF_IN pin) | ESD              |         | 250     | V     |

<sup>1</sup> Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

**ESD HANDLING:** *Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD handling precautions should be used at all times.*

**Table 3. SKY65723-81 Recommended Operating Conditions**

| Parameter  | Symbol                 | Min                   | Typ  | Max             | Units |
|--|------------------------|-----------------------|------|-----------------|-------|
| Frequency range  | f                      | 1559                  | 1575 | 1606            | MHz   |
| Supply voltage (measured at terminals of Evaluation Board) | V <sub>CC</sub>        | 1.62                  | 1.80 | 3.6             | V     |
| LNA enable:  |                        |                       |      |                 |       |
| Enable (high)  | LNA <sub>ENABLE</sub>  | V <sub>CC</sub> - 0.3 |      | V <sub>CC</sub> | V     |
| Disable (low)  | LNA <sub>DISABLE</sub> |                       | 0    | 0.3             | V     |
| Case operating temperature                                 | T <sub>C</sub>         | -40                   |      | +85             | °C    |

**Table 4. SKY65723-81 Electrical Specifications<sup>1</sup>**  
**(f = 1575 MHz, V<sub>CC</sub> = 1.8 V, V<sub>EN</sub> = 1.8 V, T<sub>C</sub> = +25 °C, Unless Otherwise Noted)**

| Parameter                                 | Symbol             | Test Condition  | Min | Typ                        | Max | Units                           |
|---|--------------------|---|-----|----------------------------|-----|---------------------------------|
| Small signal gain                         | IS21I              | P <sub>IN</sub> = -30 dBm   | 14  | 16.3                       |     | dB                              |
| Noise figure                              | NF                 |   | 1   | 1.6 <sup>2</sup>           | 3   | dB                              |
| In-band third order input intercept point | IIP3               | f <sub>1</sub> = 1575 MHz,<br>f <sub>2</sub> = 1576 MHz,<br>P <sub>IN</sub> = -30 dBm   |     | -9                         |     | dBm                             |
| 1 dB input compression point              | IP1dB              |   |     | -15.5                      |     | dBm                             |
| Reverse isolation                         | IS12I              | P <sub>IN</sub> = -30 dBm   |     | 31                         |     | dB                              |
| Input return loss                         | IS11I              | P <sub>IN</sub> = -30 dBm   |     | 10                         |     | dB                              |
| Output return loss                        | IS22I              | P <sub>IN</sub> = -30 dBm   |     | 10                         |     | dB                              |
| Supply current                            | I <sub>CC</sub>    | No RF   |     | 4                          | 5   | mA                              |
| Shutdown current                          | I <sub>LEAK</sub>  | No RF, V <sub>EN</sub> = 0 V  |     | 0.1                        | 1   | μA                              |
| Out-of-band rejection                     | OOB                | P <sub>IN</sub> = 0 dBm (in-band referred):<br>@ 777 to 798 MHz<br>@ 806 to 928 MHz<br>@ 1710 to 1980 MHz<br>@ 2400 to 2500 MHz<br>@ 5160 to 5560 MHz |     | 60<br>60<br>45<br>45<br>50 |     | dBc<br>dBc<br>dBc<br>dBc<br>dBc |
| Band 13 2 <sup>nd</sup> harmonic          | B13 <sub>2to</sub> | P <sub>IN</sub> = +15 dBm @ 787.76 MHz<br>measured @ 1575.52 MHz<br>output referred   |     | -50                        |     | dBm                             |
| LNA turn-on time                          | T <sub>ON</sub>    | P <sub>IN</sub> = -30 dBm, V <sub>CC</sub> = 1.8 V, 50%<br>of V <sub>ENABLE</sub> to 90% final RF power   |     | 1                          |     | μs                              |
| LNA turn-off time                         | T <sub>OFF</sub>   | P <sub>IN</sub> = -30 dBm, V <sub>CC</sub> = 1.8 V, 50%<br>of V <sub>ENABLE</sub> to 10% final RF power   |     | 0.2                        |     | μs                              |

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

<sup>2</sup> 0.1 dB has been de-embedded for input connector and trace loss.

**Table 5. SKY65723-81 Electrical Specifications<sup>1</sup>**  
**(f = 1575 MHz, V<sub>CC</sub> = 2.8 V, V<sub>EN</sub> = 2.8 V, T<sub>C</sub> = +25 °C, Unless Otherwise Noted)**

| Parameter                                 | Symbol             | Test Condition  | Min | Typ                        | Max | Units                           |
|---|--------------------|---|-----|----------------------------|-----|---------------------------------|
| Small signal gain                         | IS21I              | PIN = -30 dBm   | 14  | 16.8                       |     | dB                              |
| Noise figure                              | NF                 |   | 1   | 1.5 <sup>2</sup>           | 3   | dB                              |
| In-band third order input intercept point | IIP3               | f1 = 1575 MHz,<br>f2 = 1576 MHz,<br>PIN = -30 dBm   |     | -8                         |     | dBm                             |
| 1 dB input compression point              | IP1dB              |   |     | -14.5                      |     | dBm                             |
| Reverse isolation                         | IS12I              | PIN = -30 dBm   |     | 31                         |     | dB                              |
| Input return loss                         | IS11I              | PIN = -30 dBm   |     | 10                         |     | dB                              |
| Output return loss                        | IS22I              | PIN = -30 dBm   |     | 10                         |     | dB                              |
| Supply current                            | I <sub>CC</sub>    | No RF   |     | 4.2                        | 6   | mA                              |
| Shutdown current                          | I <sub>LEAK</sub>  | No RF, V <sub>EN</sub> = 0 V  |     | 0.1                        | 1   | μA                              |
| Out-of-band rejection                     | OOB                | PIN = 0 dBm (in-band referred):<br>@ 777 to 798 MHz<br>@ 806 to 928 MHz<br>@ 1710 to 1980 MHz<br>@ 2400 to 2500 MHz<br>@ 5160 to 5560 MHz |     | 60<br>60<br>45<br>45<br>50 |     | dBc<br>dBc<br>dBc<br>dBc<br>dBc |
| Band 13 2 <sup>nd</sup> harmonic          | B13 <sub>2to</sub> | PIN = +15 dBm @ 787.76 MHz<br>measured @ 1575.52 MHz<br>output referred   |     | -50                        |     | dBm                             |
| LNA turn-on time                          | T <sub>ON</sub>    | PIN = -30 dBm, V <sub>CC</sub> = 2.8 V, 50%<br>of V <sub>ENABLE</sub> to 90% final RF power   |     | 1                          |     | μs                              |
| LNA turn-off time                         | T <sub>OFF</sub>   | PIN = -30 dBm, V <sub>CC</sub> = 2.8 V, 50%<br>of V <sub>ENABLE</sub> to 10% final RF power   |     | 0.2                        |     | μs                              |

<sup>1</sup> Performance is guaranteed only under the conditions listed in this table.

<sup>2</sup> 0.1 dB has been de-embedded for input connector and trace loss.

## Evaluation Board Description

The SKY65723-81 Evaluation Board is used to test the performance of the SKY65723-81 LNA. The Evaluation Board schematic diagram is shown in Figure 3. An assembly drawing for the Evaluation Board is shown in Figure 4. Table 6 provides the Bill of Materials (BOM) list for Evaluation Board components.

## Package Dimensions

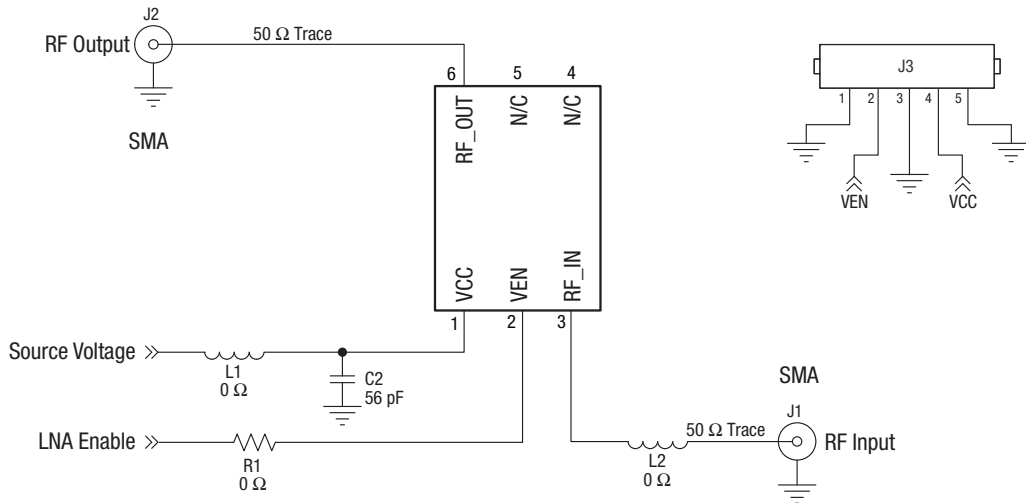
The Evaluation Board layer details for the SKY65723-81 are shown in Figure 5. Layer detail physical characteristics are shown in Figure 6. The PCB layout footprint is provided in Figure 7. Figure 8 shows the typical part marking. Package dimensions are shown in Figure 9, and tape and reel dimensions are provided in Figure 10.

## Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY65723-81 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages*, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



Note: DNI components are not shown.

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Figure 3. SKY65723-81 Evaluation Board Schematic

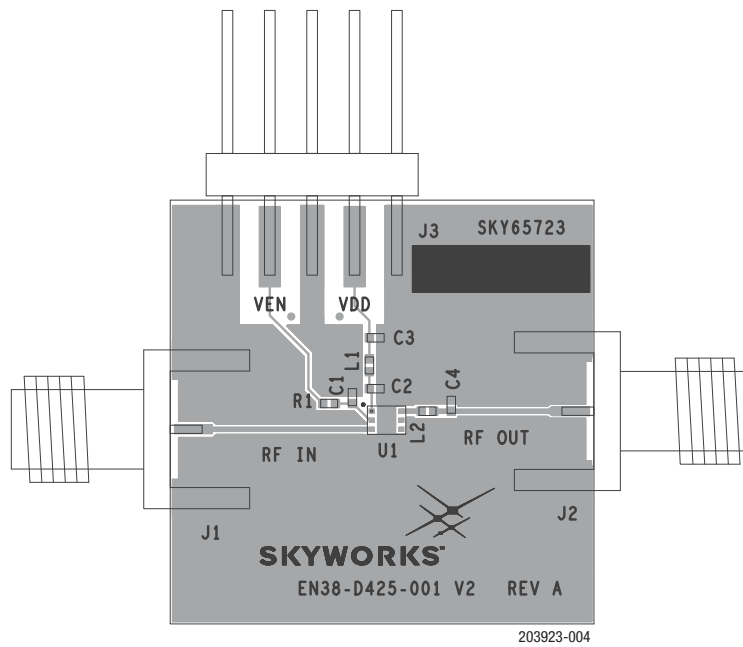
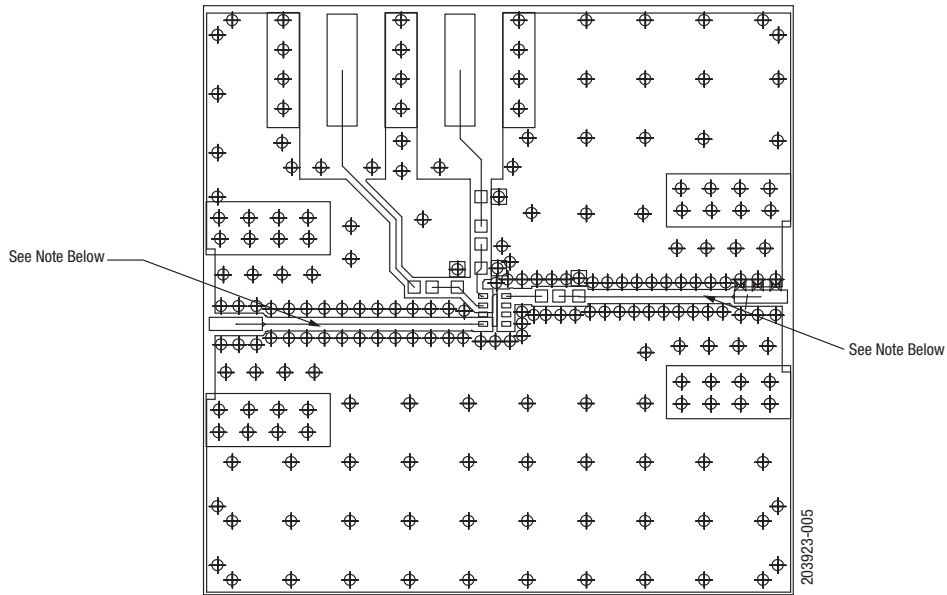


Figure 4. SKY65723-81 Evaluation Board Assembly Diagram

Table 6. SKY65723-81 Evaluation Board Bill of Materials

| Component  | Size | Value | Manufacturer | Mfr Part Number    |
|------------|------|-------|--------------|--------------------|
| C1, C3, C4 | 0402 | DNI   |              |                    |
| C2         | 0402 | 56 pF | Murata       | GRM0335C1E560JA01D |
| L1, L2, R1 | 0402 | 0 Ω   | Panasonic    | ERJ-2GE0R00X       |



CONDUCTORS INDICATED SHALL BE 0.0135 +/-0.001 WITH A COPLANAR SPACING OF .005 +/-0.001

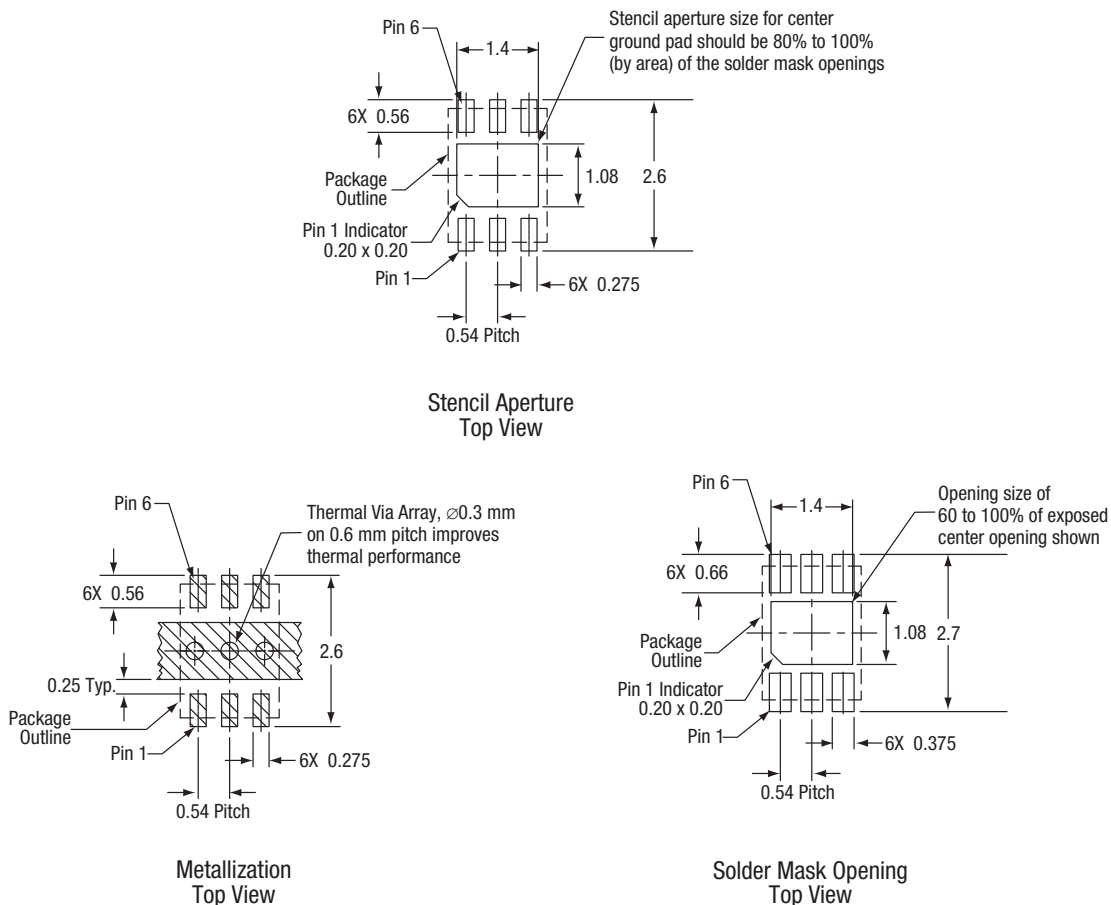
TEST FOR 50 OHMS +/- 10% ON LAYER 1.

**Figure 5. SKY65723-81 Evaluation Board Layer Details**

|  | Cross Section | Name              | Thickness                             | Materials      |
|--|---------------|-------------------|---------------------------------------|----------------|
|  |               | TOP SOLDERMASK    |                                       |                |
|  |               | L1                | (0.0007)                              | 1/2 OZ. COPPER |
|  |               | DIELECTRIC        | 0.008                                 | ROGERS 4003    |
|  |               | L2                | (0.0014)                              | 1 OZ. COPPER   |
|  |               | DIELECTRIC        | ADJUST TO MEET REQUIRED THICKNESS FR4 |                |
|  |               | L3                | (0.0007)                              | 1/2 OZ. COPPER |
|  |               | BOTTOM SOLDERMASK |                                       |                |

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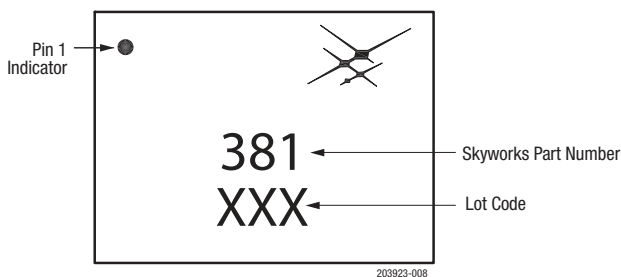
**Figure 6. SKY65723-81 Layer Detail Physical Characteristics**



All dimensions are in millimeters

203923-007

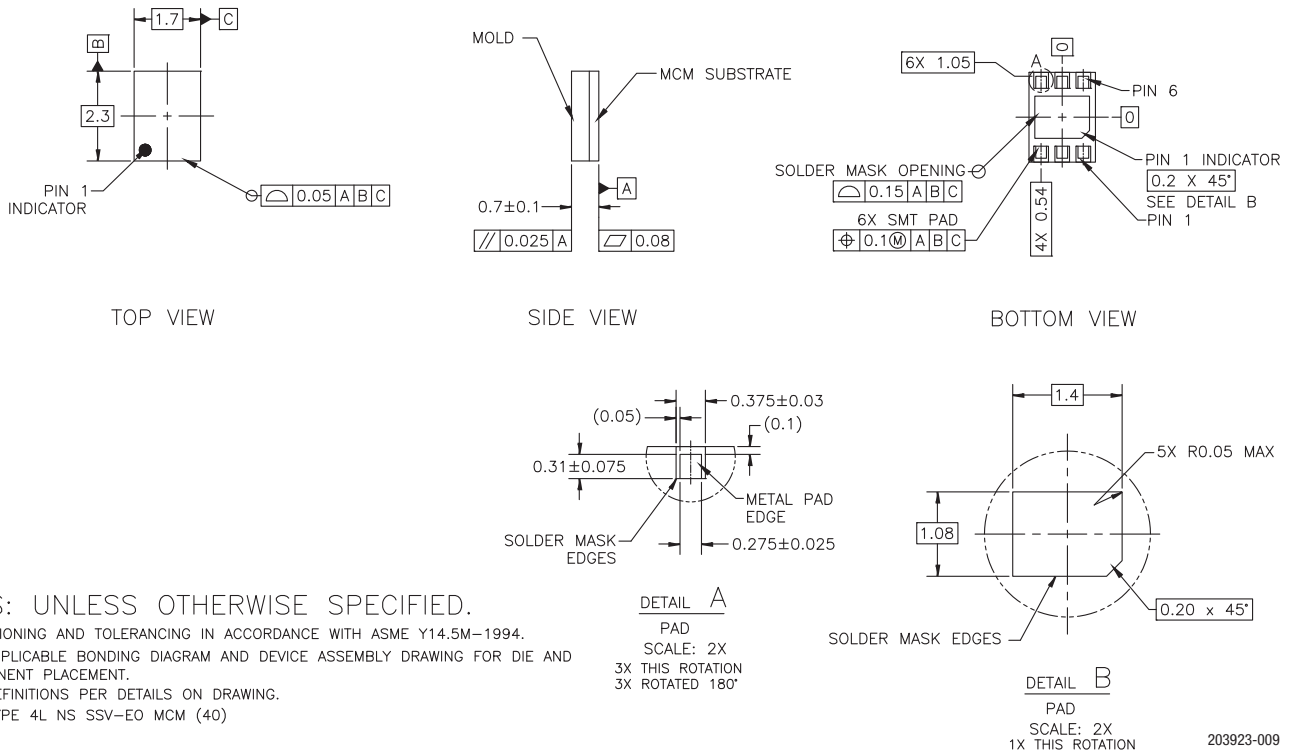
Figure 7. SKY65723-81 PCB Layout Footprint



203923-008

Figure 8. Typical Part Marking

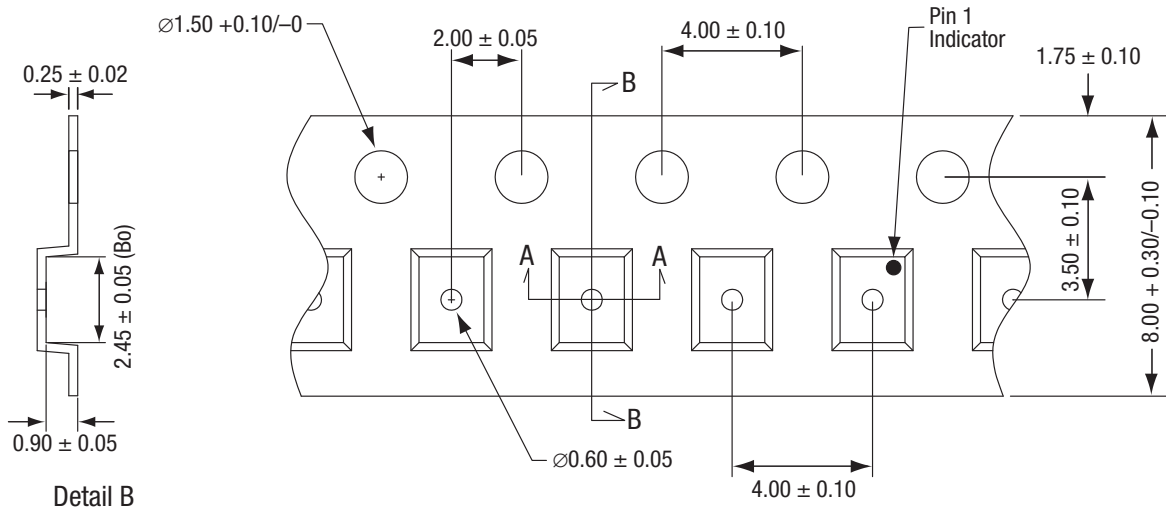




NOTES: UNLESS OTHERWISE SPECIFIED.

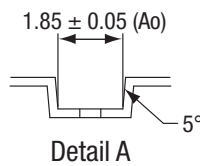
1. DIMENSIONING AND TOLERANCING IN ACCORDANCE WITH ASME Y14.5M-1994.
2. SEE APPLICABLE BONDING DIAGRAM AND DEVICE ASSEMBLY DRAWING FOR DIE AND COMPONENT PLACEMENT.
3. PAD DEFINITIONS PER DETAILS ON DRAWING.
4. PCB TYPE 4L NS SSV-EO MCM (40)

Figure 9. SKY65723-81 Package Dimensions



Notes:

1. Carrier tape: black conductive polycarbonate.
2. Cover tape material: transparent adhesive material.
3. ESD-surface resistivity is  $\geq 1 \times 10^5 \sim \leq 1 \times 10^8$  Ohms/square per EIA, JEDEC TNR Specification.
4. 10-sprocket hole pitch cumulative tolerance:  $\pm 0.20$  mm.
5.  $A_o$  and  $B_o$  measured on plane 0.30 mm above the bottom of pocket.
6. Camber not to exceed 1 mm in 250 mm.
7. All measurements are in millimeters.



203923-010

Figure 10. SKY65723-81 Tape and Reel Dimensions

## Ordering Information

| Product Description   | Product Part Number | Evaluation Board Part Number |
|---|---------------------|------------------------------|
| SKY65723-81: Low-Noise Amplifier FEM with GPS/GNSS/BDS Filter | SKY65723-81         | 65723-81-EVB                 |

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